L Number	Hits	Search Text	DB	Time stamp
1	12	257/677 and solder ADJ BALL	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/07 13:23
2	392	257/678 and solder ADJ BALL	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/07 13:45
3	97	257/679 and solder ADJ BALL	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/07 13:49
4	80	257/680 and solder ADJ BALL	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/07 13:52
5	482	257/698 and solder ADJ BALL	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/07 13:52
-	1	("6187612").PN.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/05 17:48
-	1	"20020027441"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/05 17:55
-	65	lead adj frame and protrusion and solder adj ball	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/05 18:25
-	371	257/666 and solder ADJ BALL	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/05 18:40
-	13	("4069000" | "5244838" | "5293072" | "5635755" | "5656863" | "5783461" | "5847455" | "5893724" | "5923954" | "5925934" | "5930603" | "5982026" | "5989935").PN.	USPAT	2004/08/05 18:30
-	78	257/667 and solder ADJ BALL	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/05 18:42
-	371	257/668 and solder ADJ BALL	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/06 20:50
-	113	257/673 and solder ADJ BALL	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/06 20:55
-	196	257/676 and solder ADJ BALL	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/08/07 13:21